

- QFN package 3 x 3 x 0.9 mm<sup>3</sup>
- High-resolution module, 13 cm
- Supply voltage: 1.5 to 3.6 V
- Fast conversion down to 0.5 ms
- Low power, 0.6 μA (standby ≤ 0.1 μA at 25°C)
- Integrated digital pressure sensor (24 bit  $\Delta\Sigma$  ADC)
- Operating range: 300 to 1200 mbar, -40 to +85 °C
- I<sup>2</sup>C interface
- No external components (internal oscillator)

## **DESCRIPTION**

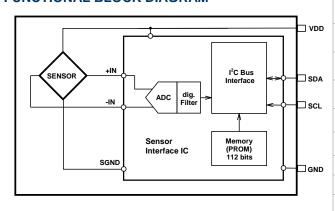
The MS5637 is an ultra-compact micro altimeter. It is optimized for altimeter and barometer applications in Smart-phones and Tablet PCs. The altitude resolution at sea level is 13 cm of air. The sensor module includes a high-linearity pressure sensor and an ultra-low power 24 bit  $\Delta\Sigma$  ADC with internal factory-calibrated coefficients. It provides a precise digital 24-bit pressure and temperature value and different operation modes that allow the user to optimize for conversion speed and current consumption. A high-resolution temperature output allows the implementation of an altimeter/thermometer function without any additional sensor. The MS5637 can be interfaced to any microcontroller with I $^2$ C-bus interface. The communication protocol is simple, without the need of programming internal registers in the device. Small dimensions of 3 x 3 x 0.9 mm $^3$  allow the integration in mobile devices. This new sensor module generation is based on leading MEMS technology and latest benefits from MEAS Switzerland proven experience and know-how in high volume manufacturing of altimeter modules, which has been widely used for over a decade. The sensing principle employed leads to very low hysteresis and high stability of both pressure and temperature signal.

## **FEATURES**

## **FIELD OF APPLICATION**

Smart-phones
Tablet PCs
Personal navigation devices

#### **FUNCTIONAL BLOCK DIAGRAM**



#### **TECHNICAL DATA**

| Sensor Performances (VDE                                      | o = 3 V | )                              |          |          |
|---|---------|--------------------------------|----------|----------|
| Pressure  | Min     | Тур                            | Max      | Unit     |
| Maximum Range   | 10      |                                | 2000     | mbar     |
| ADC   |         | 24                             |          | bit      |
| Resolution (1)  | -       | / 0.062/<br>028 / 0.0<br>0.016 |          | mbar     |
| Error band at 25°C,<br>300 to 1200 mbar                       | -2      |                                | +2       | mbar     |
| Error band, -20°C to + 85°C 300 to 1200 mbar (2)              | -4      |                                | +4       | mbar     |
| Response time (1)   |         | 1.1 / 2.1<br>.22 / 16.4        |          | ms       |
| Long term stability   |         | ±1                             |          | mbar/yr  |
| Temperature   | Min     | Тур                            | Max      | Unit     |
| Range   | -40     |                                | +85      | °C       |
| Resolution  |         | <0.01                          |          | °C       |
| Accuracy at 25°C  | -1      |                                | +1       | °C       |
| Notes: (1) Oversampling Ratio: 25 (2) With auto-zero at one p |         |                                | 48 / 409 | 6 / 8192 |

## PERFORMANCE SPECIFICATIONS

## **ABSOLUTE MAXIMUM RATINGS**

| Parameter                        | Symbol           | Conditions              | Min. | Тур. | Max. | Unit |
|----------------------------------|------------------|-------------------------|------|------|------|------|
| Supply voltage                   | $V_{DD}$         |                         | -0.3 |      | +3.6 | V    |
| Storage temperature              | Ts               |                         | -20  |      | +85  | °C   |
| Overpressure                     | P <sub>max</sub> |                         |      | 6    |      | bar  |
| Maximum Soldering<br>Temperature | T <sub>max</sub> | 40 sec max              |      |      | 250  | °C   |
| ESD rating                       |                  | Human Body<br>Model     | -2   |      | +2   | kV   |
| Latch up                         |                  | JEDEC standard<br>No 78 | -100 |      | +100 | mA   |

## **ELECTRICAL CHARACTERISTICS**

| Parameter                | Symbol          | Conditions                 |          | Min. | Тур.  | Max. | Unit |
|--------------------------|-----------------|----------------------------|----------|------|-------|------|------|
| Operating Supply voltage | $V_{DD}$        |                            |          | 1.5  | 3.0   | 3.6  | V    |
| Operating Temperature    | Т               |                            |          | -40  | +25   | +85  | °C   |
|                          |                 | OSR                        | 8192     |      | 20.09 |      |      |
| Supply current           | I <sub>DD</sub> |                            | 4096     |      | 10.05 |      |      |
|                          |                 |                            | 2048     |      | 5.02  |      | μA   |
| (1 sample per sec.)      |                 |                            | 1024     |      | 2.51  |      | μA   |
|                          |                 |                            | 512      |      | 1.26  |      |      |
|                          |                 |                            | 256      |      | 0.63  |      |      |
| Peak supply current      |                 | during conver              | sion     |      | 1.25  |      | mA   |
| Standby supply current   |                 | at 25°C (V <sub>DD</sub> : | = 3.0 V) |      | 0.01  | 0.1  | μA   |
| VDD Capacitor            |                 | from VDD to 0              | GND      | 100  | 470   |      | nF   |

## **ANALOG DIGITAL CONVERTER (ADC)**

| Parameter       | Symbol         | Conditions |      | Min. | Тур.  | Max. | Unit |
|-----------------|----------------|------------|------|------|-------|------|------|
| Output Word     |                |            |      |      | 24    |      | bit  |
| Conversion time |                | OSR        | 8192 |      | 16.44 |      |      |
|                 |                |            | 4096 |      | 8.22  |      |      |
|                 |                |            | 2048 |      | 4.13  |      |      |
|                 | t <sub>c</sub> |            | 1024 |      | 2.08  |      | ms   |
|                 |                |            | 512  |      | 1.06  |      |      |
|                 |                |            | 256  |      | 0.54  |      |      |

# PERFORMANCE SPECIFICATIONS (CONTINUED)

## PRESSURE OUTPUT CHARACTERISTICS (V<sub>DD</sub> = 3.0 V, T = 25 °C UNLESS OTHERWISE NOTED)

| Parameter   | Conditio              | ns                                    | Min. | Тур.  | Max. | Unit    |
|---|-----------------------|---------------------------------------|------|-------|------|---------|
| Operating Pressure Range                              | P <sub>range</sub>    |                                       | 300  |       | 1200 | mbar    |
| Extended Pressure Range                               | P <sub>ext</sub>      | Linear Range of ADC                   | 10   |       | 2000 | mbar    |
| Relative Accuracy, autozero at one pressure point (1) | 700100                | 00 mbar at 25°C                       |      | ±0.1  |      | mbar    |
| Absolute Accuracy,                                    | 300120                | 0 mbar at 25°C                        | -2   |       | +2   | mbar    |
| no autozero   | 300120                | 0mbar, -2085°C                        | -4   |       | +4   | mbar    |
|   | OSR                   | 8192                                  |      | 0.016 |      |         |
|   |                       | 4096                                  |      | 0.021 |      |         |
| D 1 ( DMO   |                       | 2048                                  |      | 0.028 |      |         |
| Resolution RMS  |                       | 1024                                  |      | 0.039 |      | mbar    |
|   |                       | 512                                   |      | 0.062 |      |         |
|   |                       | 256                                   |      | 0.11  |      |         |
| Maximum error with supply voltage                     | V <sub>DD</sub> = 1.5 | 5 V 3.6 V                             |      | ±0.5  |      | mbar    |
| Long-term stability                                   |                       |                                       |      | ±1    |      | mbar/yr |
|   | IPC/JEDI              | EC J-STD-020C                         |      |       |      |         |
| Reflow soldering impact                               |                       | lication note AN808<br>meas-spec.com) |      | -1    |      | mbar    |
| Recovering time after reflow (2)                      |                       |                                       |      | 3     |      | days    |

<sup>(1)</sup> Characterized value performed on qualification devices

## TEMPERATURE OUTPUT CHARACTERISTICS (V<sub>DD</sub> = 3 V, T = 25°C UNLESS OTHERWISE NOTED)

| Parameter                         | Conditions                    |      | Min. | Тур.  | Max. | Unit |
|-----------------------------------|-------------------------------|------|------|-------|------|------|
| Absolute Acquire ov               | at 25°C                       |      | -1   |       | +1   | °C   |
| Absolute Accuracy                 | -2085°C                       |      | -2   |       | +2   | C    |
| Maximum error with supply voltage | V <sub>DD</sub> = 1.5 V 3.6 V |      |      | ±0.3  |      | °C   |
|                                   | OSR                           | 8192 |      | 0.002 |      |      |
|                                   |                               | 4096 |      | 0.003 |      |      |
| Decalution DMC                    |                               | 2048 |      |       |      | °C   |
| Resolution RMS                    |                               | 1024 |      | 0.006 |      |      |
|                                   |                               | 512  |      | 0.009 |      |      |
|                                   |                               | 256  |      | 0.012 |      |      |

<sup>(2)</sup> Recovering time at least 66% of the reflow impact



## PERFORMANCE SPECIFICATIONS (CONTINUED)

## **DIGITAL INPUTS (SDA, SCL)**

| Parameter             | Symbol            | Conditions | Min.                | Тур. | Max.                 | Unit |
|-----------------------|-------------------|------------|---------------------|------|----------------------|------|
| Serial data clock     | SCL               |            |                     |      | 400                  | kHz  |
| Input high voltage    | V <sub>IH</sub>   |            | 80% V <sub>DD</sub> |      | 100% V <sub>DD</sub> | V    |
| Input low voltage     | V <sub>IL</sub>   |            | 0% V <sub>DD</sub>  |      | 20% V <sub>DD</sub>  | V    |
| Input leakage current | I <sub>leak</sub> | T = 25 °C  |                     |      | 0.1                  | μΑ   |
| Input capacitance     | C <sub>IN</sub>   |            |                     | 6    |                      | pF   |

## **DIGITAL OUTPUTS (SDA)**

| Parameter           | Symbol          | Conditions                 | Min.                | Тур. | Max.                 | Unit |
|---------------------|-----------------|----------------------------|---------------------|------|----------------------|------|
| Output high voltage | V <sub>OH</sub> | I <sub>source</sub> = 1 mA | 80% V <sub>DD</sub> |      | 100% V <sub>DD</sub> | V    |
| Output low voltage  | V <sub>OL</sub> | I <sub>sink</sub> = 1 mA   | 0% V <sub>DD</sub>  |      | 20% V <sub>DD</sub>  | V    |
| Load capacitance    | $C_LOAD$        |                            |                     | 16   |                      | pF   |

## **FUNCTIONAL DESCRIPTION**

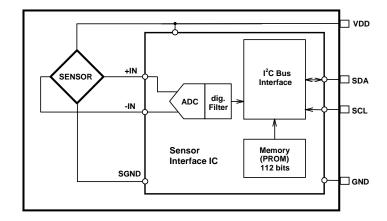


Figure 1: Block diagram

#### **GENERAL**

The MS5637 consists of a piezo-resistive sensor and a sensor interface integrated circuit. The main function of the MS5637 is to convert the uncompensated analogue output voltage from the piezo-resistive pressure sensor to a 24-bit digital value, as well as providing a 24-bit digital value for the temperature of the sensor.

## **FACTORY CALIBRATION**

Every module is individually factory calibrated at two temperatures and two pressures. As a result, 6 coefficients necessary to compensate for process variations and temperature variations are calculated and stored in the 112-bit PROM of each module. These bits (partitioned into 6 coefficients) must be read by the microcontroller software and used in the program converting D1 and D2 into compensated pressure and temperature values.

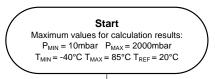
#### **SERIAL I2C INTERFACE**

The external microcontroller clocks in the data through the input SCL (Serial CLock) and SDA (Serial DAta). The sensor responds on the same pin SDA which is bidirectional for the I<sup>2</sup>C bus interface. So this interface type uses only 2 signal lines and does not require a chip select.

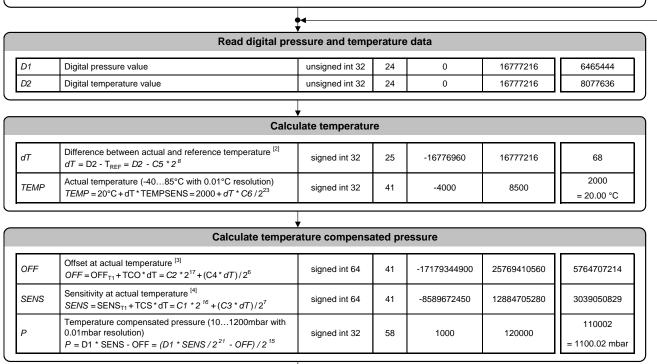
| Module reference | Mode             | Pins used |
|------------------|------------------|-----------|
| MS563702BA03     | I <sup>2</sup> C | SDA, SCL  |



#### PRESSURE AND TEMPERATURE CALCULATION



|          | Read calibration data (factory calibrated) from PROM  |                 |          |     |       |           |  |  |  |  |  |  |  |  |
|----------|---|-----------------|----------|-----|-------|-----------|--|--|--|--|--|--|--|--|
| Variable | Description   Equation                                | Recommended     | Size [1] | Val | ue    | Example / |  |  |  |  |  |  |  |  |
| variable | Description   Equation                                | variable type   | [bit]    | min | max   | Typical   |  |  |  |  |  |  |  |  |
| C1       | Pressure sensitivity   SENS <sub>T1</sub>             | unsigned int 16 | 16       | 0   | 65535 | 46372     |  |  |  |  |  |  |  |  |
| C2       | Pressure offset   OFF <sub>T1</sub>                   | unsigned int 16 | 16       | 0   | 65535 | 43981     |  |  |  |  |  |  |  |  |
| СЗ       | Temperature coefficient of pressure sensitivity   TCS | unsigned int 16 | 16       | 0   | 65535 | 29059     |  |  |  |  |  |  |  |  |
| C4       | Temperature coefficient of pressure offset   TCO      | unsigned int 16 | 16       | 0   | 65535 | 27842     |  |  |  |  |  |  |  |  |
| C5       | Reference temperature   T <sub>REF</sub>              | unsigned int 16 | 16       | 0   | 65535 | 31553     |  |  |  |  |  |  |  |  |
| C6       | Temperature coefficient of the temperature   TEMPSENS | unsigned int 16 | 16       | 0   | 65535 | 28165     |  |  |  |  |  |  |  |  |



Notes

| Maximal size of intermediate result during evaluation of variable min and max have to be defined

[2] min and max have to be defined [3] min and max have to be defined [4] min and max have to be defined

Figure 2: Flow chart for pressure and temperature reading and software compensation.

Display pressure and temperature value

#### SECOND ORDER TEMPERATURE COMPENSATION

In order to obtain best accuracy over temperature range, particularly at low temperature, it is recommended to compensate the non-linearity over the temperature. This can be achieved by correcting the calculated temperature, offset and sensitivity by a second-order correction factor. The second-order factors are calculated as follows:

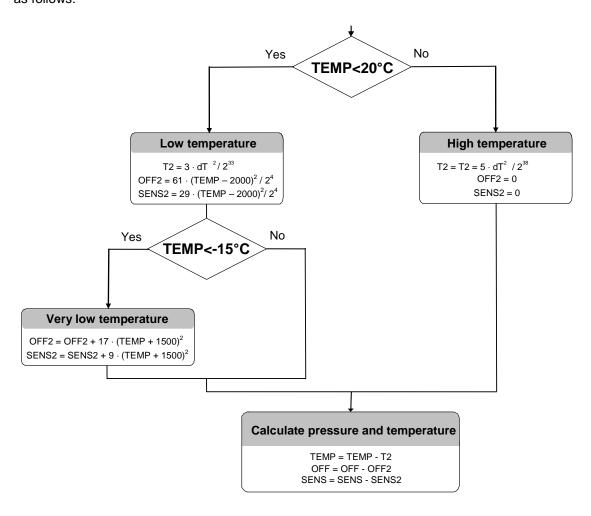


Figure 3: Flow chart for pressure and temperature to the optimum accuracy.

## I<sup>2</sup>C INTERFACE

#### **COMMANDS**

The MS5637 has only five basic commands:

- 1. Reset
- 2. Read PROM (112 bit of calibration words)
- 3. D1 conversion
- 4. D2 conversion
- 5. Read ADC result (24 bit pressure / temperature)

Each  $I^2C$  communication message starts with the start condition and it is ended with the stop condition. The MS5637 address is 1110110x (write: x=0, read: x=1).

Size of each command is 1 byte (8 bits) as described in the table below. After ADC read commands, the device will return 24 bit result and after the PROM read 16 bit results. The address of the PROM is embedded inside of the PROM read command using the a2, a1 and a0 bits.

|                       | Comi     | mand     | byte |     |             |             |             |      | hex value       |
|-----------------------|----------|----------|------|-----|-------------|-------------|-------------|------|-----------------|
| Bit number            | 0        | 1        | 2    | 3   | 4           | 5           | 6           | 7    |                 |
| Bit name              | PRO<br>M | CO<br>NV | -    | Тур | Ad2/<br>Os2 | Ad1/<br>Os1 | Ad0/<br>Os0 | Stop |                 |
| Command               |          |          |      |     |             |             |             |      |                 |
| Reset                 | 0        | 0        | 0    | 1   | 1           | 1           | 1           | 0    | 0x1E            |
| Convert D1 (OSR=256)  | 0        | 1        | 0    | 0   | 0           | 0           | 0           | 0    | 0x40            |
| Convert D1 (OSR=512)  | 0        | 1        | 0    | 0   | 0           | 0           | 1           | 0    | 0x42            |
| Convert D1 (OSR=1024) | 0        | 1        | 0    | 0   | 0           | 1           | 0           | 0    | 0x44            |
| Convert D1 (OSR=2048) | 0        | 1        | 0    | 0   | 0           | 1           | 1           | 0    | 0x46            |
| Convert D1 (OSR=4096) | 0        | 1        | 0    | 0   | 1           | 0           | 0           | 0    | 0x48            |
| Convert D1 (OSR=8192) | 0        | 1        | 0    | 0   | 1           | 0           | 1           | 0    | 0x4A            |
| Convert D2 (OSR=256)  | 0        | 1        | 0    | 1   | 0           | 0           | 0           | 0    | 0x50            |
| Convert D2 (OSR=512)  | 0        | 1        | 0    | 1   | 0           | 0           | 1           | 0    | 0x52            |
| Convert D2 (OSR=1024) | 0        | 1        | 0    | 1   | 0           | 1           | 0           | 0    | 0x54            |
| Convert D2 (OSR=2048) | 0        | 1        | 0    | 1   | 0           | 1           | 1           | 0    | 0x56            |
| Convert D2 (OSR=4096) | 0        | 1        | 0    | 1   | 1           | 0           | 0           | 0    | 0x58            |
| Convert D2 (OSR=8192) | 0        | 1        | 0    | 1   | 1           | 0           | 1           | 0    | 0x5A            |
| ADC Read              | 0        | 0        | 0    | 0   | 0           | 0           | 0           | 0    | 0x00            |
| PROM Read             | 1        | 0        | 1    | 0   | Ad2         | Ad1         | Ad0         | 0    | 0xA0 to<br>0xAE |

Figure 4: Command structure

#### **RESET SEQUENCE**

The Reset sequence shall be sent once after power-on to make sure that the calibration PROM gets loaded into the internal register. It can be also used to reset the device PROM from an unknown condition.

The reset can be sent at any time. In the event that there is not a successful power on reset this may be caused by the SDA being blocked by the module in the acknowledge state. The only way to get the MS5637 to function is to send several SCLs followed by a reset sequence or to repeat power on reset.

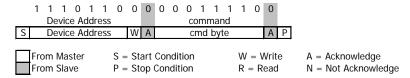


Figure 5: I<sup>2</sup>C Reset Command

#### **PROM READ SEQUENCE**

The read command for PROM shall be executed once after reset by the user to read the content of the calibration PROM and to calculate the calibration coefficients. There are in total 7 addresses resulting in a total memory of 112 bit. Addresses contains factory data and the setup, calibration coefficients, the serial code and CRC. The command sequence is 8 bits long with a 16 bit result which is clocked with the MSB first. The PROM Read command consists of two parts. First command sets up the system into PROM read mode. The second part gets the data from the system.

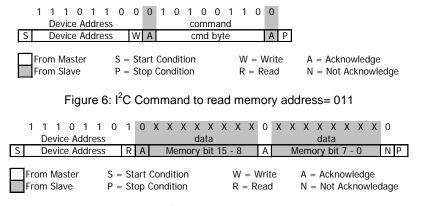
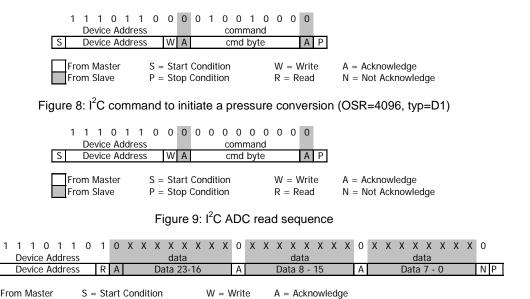


Figure 7: I<sup>2</sup>C answer from MS5637

#### **CONVERSION SEQUENCE**

The conversion command is used to initiate uncompensated pressure (D1) or uncompensated temperature (D2) conversion. After the conversion, using ADC read command the result is clocked out with the MSB first. If the conversion is not executed before the ADC read command, or the ADC read command is repeated, it will give 0 as the output result. If the ADC read command is sent during conversion the result will be 0, the conversion will not stop and the final result will be wrong. Conversion sequence sent during the already started conversion process will yield incorrect result as well. A conversion can be started by sending the command to MS5637. When command is sent to the system it stays busy until conversion is done. When conversion is finished the data can be accessed by sending a Read command, when an acknowledge is sent from the MS5637, 24 SCL cycles may be sent to receive all result bits. Every 8 bits the system waits for an acknowledge signal.





N = Not Acknowledge

Figure 10: I<sup>2</sup>C answer from MS5637

R = Read

## CYCLIC REDUNDANCY CHECK (CRC)

P = Stop Condition

From Slave

MS5637 contains a PROM memory with 112-Bit. A 4-bit CRC has been implemented to check the data validity in memory. The application note AN520 describes in detail CRC-4 code used.

| A<br>d<br>d | D B 1 5 | D<br>B<br>1<br>4    | D<br>B<br>1<br>3 | D<br>B<br>1<br>2 | D<br>B<br>1 | D<br>B<br>1<br>0 | D<br>B<br>9 | D<br>B<br>8 | D<br>B<br>7 | D<br>B<br>6 | D<br>B<br>5 | D<br>B<br>4 | D<br>B<br>3 | D<br>B<br>2 | D<br>B<br>1 | D<br>B<br>0 |
|-------------|---------|---------------------|------------------|------------------|-------------|------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| 0           |         | CRC Factory defined |                  |                  |             |                  |             |             |             |             |             |             |             |             |             |             |
| 1           |         | C1                  |                  |                  |             |                  |             |             |             |             |             |             |             |             |             |             |
| 2           |         |                     |                  |                  |             |                  |             | С           | 2           |             |             |             |             |             |             |             |
| 3           |         |                     |                  |                  |             |                  |             | С           | 3           |             |             |             |             |             |             |             |
| 4           |         |                     |                  |                  |             |                  |             | С           | 4           |             |             |             |             |             |             |             |
| 5           | C5      |                     |                  |                  |             |                  |             |             |             |             |             |             |             |             |             |             |
| 6           |         |                     |                  |                  |             |                  |             | С           | 6           |             |             |             |             |             |             |             |

Figure 11: Memory PROM mapping

## **APPLICATION CIRCUIT**

The MS5637 is a circuit that can be used in conjunction with a microcontroller in mobile altimeter applications.

## I<sup>2</sup>C protocol communication

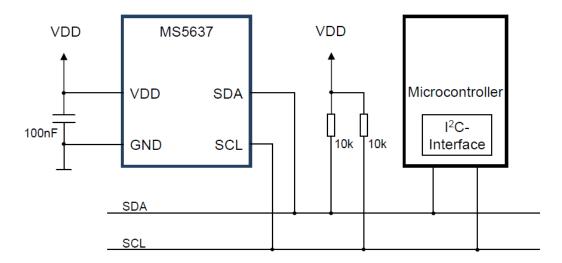
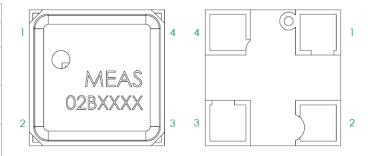


Figure 12: Typical application circuit

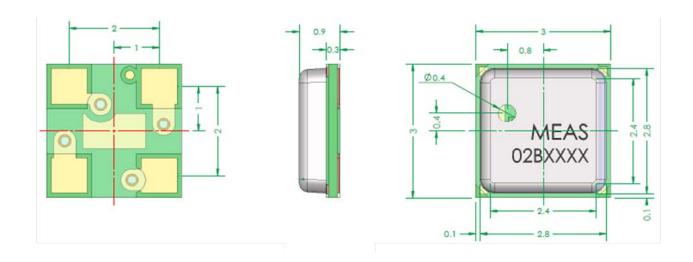


## **PIN CONFIGURATION**

| Pin | Name | Туре | Function                |  |
|-----|------|------|-------------------------|--|
| 1   | VDD  | Р    | Positive supply voltage |  |
| 2   | SDA  | I/O  | I <sup>2</sup> C data   |  |
| 3   | SCL  | I    | I <sup>2</sup> C clock  |  |
| 4   | GND  | ı    | Ground                  |  |



## **DEVICE PACKAGE OUTLINE**



Notes:

- (1) Dimensions in mm
- (2) General tolerance: ±0.1

Figure 13: MS5637 package outline

## **RECOMMENDED PAD LAYOUT**

Pad layout for bottom side of the MS5637 soldered onto printed circuit board.

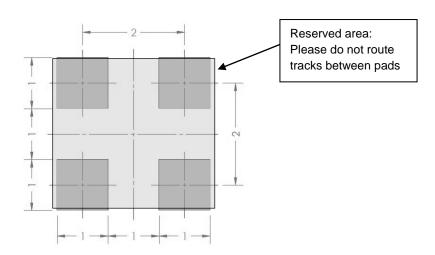
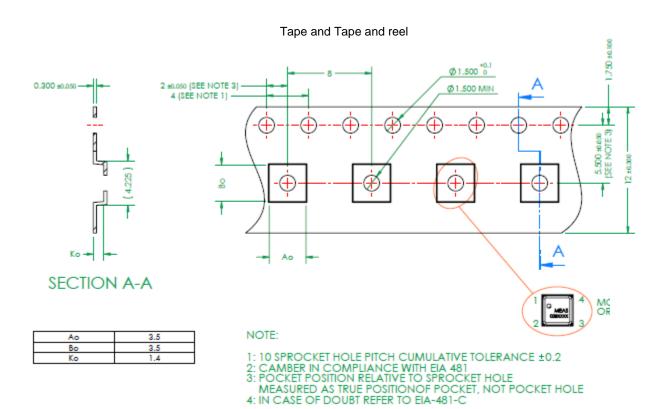


Figure 14: MS5637 pad layout

## **SHIPPING PACKAGE**





## MOUNTING AND ASSEMBLY CONSIDERATIONS

#### **SOLDERING**

Please refer to the application note AN808 available on our website for all soldering issues.

#### **MOUNTING**

The MS5637 can be placed with automatic Pick & Place equipment using vacuum nozzles. It will not be damaged by the vacuum. Due to the low stress assembly the sensor does not show pressure hysteresis effects. It is important to solder all contact pads.

#### **CONNECTION TO PCB**

The package outline of the module allows the use of a flexible PCB for interconnection. This can be important for applications in watches and other special devices.

#### **CLEANING**

The MS5637 has been manufactured under clean-room conditions. It is therefore recommended to assemble the sensor under class 10'000 or better conditions. Should this not be possible, it is recommended to protect the sensor opening during assembly from entering particles and dust. To avoid cleaning of the PCB, solder paste of type "no-clean" shall be used. Cleaning might damage the sensor!

## **ESD PRECAUTIONS**

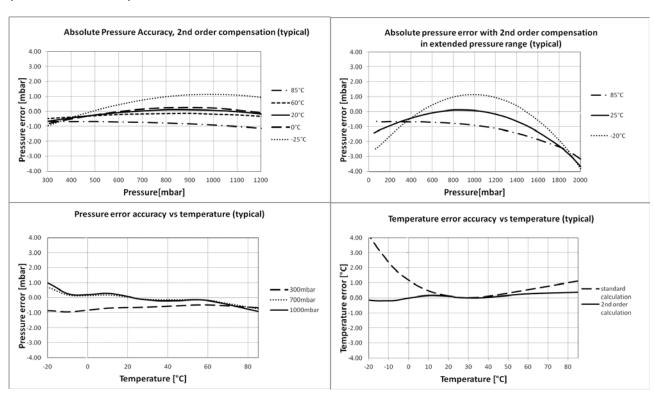
The electrical contact pads are protected against ESD up to 2 kV HBM (human body model). It is therefore essential to ground machines and personnel properly during assembly and handling of the device. The MS5637 is shipped in antistatic transport boxes. Any test adapters or production transport boxes used during the assembly of the sensor shall be of an equivalent antistatic material.

#### **DECOUPLING CAPACITOR**

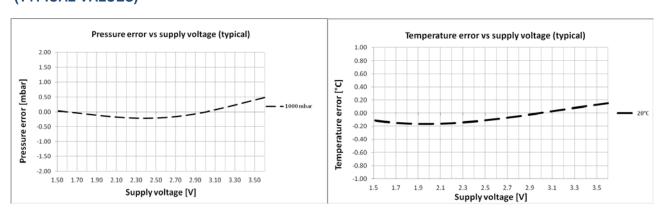
Particular care must be taken when connecting the device to the power supply. A 100nF minimum ceramic capacitor must be placed as close as possible to the MS5637 VDD pin. This capacitor will stabilize the power supply during data conversion and thus, provide the highest possible accuracy.

## TYPICAL PERFORMANCE CHARACTERISTICS

# PRESSURE AND TEMPERATURE ERROR VERSUS PRESSURE AND TEMPERATURE (TYPICAL VALUES)



# PRESSURE AND TEMPERATURE ERROR VERSUS POWER SUPPLY (TYPICAL VALUES)





## ORDERING INFORMATION

| Product Code  | Product                      | Art. No         | Delivery Form |
|---------------|------------------------------|-----------------|---------------|
| MS5637-02BA03 | Micro Altimeter Module 3x3mm | MS563702BA03-50 | Tape and reel |

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